Europhys. Lett., (), pp. ()

Current ow past an etched barrier: eld em ission from a two-dim ensional electron gas

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(received; accepted)

PACS.73.40Kp { III-V sem iconductor-to-sem iconductor contacts, p-n junctions, and heterojunctions.

PACS.79.70.+ q{ Field em ission, ionization, evaporation, and desorption.

A b stract. { We not that, under appropriate conditions, electrons can pass a barrier etched across a two dimensional electron gas (2DEG) by eldemission from the GaAs/AlGaAs heterojunction into a second, low-density 2DEG from eddeep in the substrate. The current-voltage characteristics exhibit a rapid increase in the current at the eldemission threshold and intrinsic bistability above this threshold, consistent with a heating instability occurring in the second 2DEG. These results may explain similar behaviour recently seen in a number of front-gated devices by several groups.

Extensive studies of two-dimensional electron systems over the last two decades have relied on the ability to trap electrons at an interface between two materials with dierent band energies. Most popular amongst these systems is the high-mobility GaAs/Al_xGal₁ As heterojunction [1]. Here the electrons are conned principally by attraction to remote donors placed in the AlGaAs. However, in order for there to be complete connement there must also exist an electriceld in the GaAs substrate pushing the electrons towards the heterojunction. In practice, this substrate eld is typically provided by negative charge on residual acceptors in the substrate and surface boundary conditions [2]. A very interesting situation arises if this connement eld vanishes. The electrons are then predicted to be very weakly bound at the interface, by the work function of the 2DEG, as discussed by Groshev and Schoen [3]. The work function depends sensitively on the density of the 2DEG and is strongly in uenced by many-body electrons into the substrate may be anticipated in a weak electricely eld applied perpendicular to the interface.

In this letter we discuss a simple device that demonstrates the eldemission of electrons from a 2DEG. We not that a current can ow past an etched barrier in a 2DEG if the

Typeset using EURO-TEX

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substrate eld is adjusted using a positive voltage applied to a back gate. The electrons are eld em itted from the 2DEG and travel undermeath the etched barrier. The magnetic eld dependence demonstrates that the current is carried via a low-density 2DEG formed at an upside-down heterojunction below the uppermost GaAs substrate layer. The observed current-voltage characteristics in this regime are highly nonlinear. Above a threshold bias the current rises rapidly and exhibits bistability. We show that this bistability results from them al runaway due to heating of the (initially localized) electrons in lower 2DEG by the eld-em itted electrons from the upper 2DEG.

These results are important for three reasons. First, they demonstrate a simple geometry in which the process of eldemission from a 2DEG can be studied. Second, they illustrate the existence of a thermal instability in an initially insulating, low-density 2DEG. Finally, they of er insight into a number of recent experiments on transport across a lateral barrier [4, 5, 6, 7] on a GaAs/AIGaAs heterostructure. The latter experiments all revealed very similar behaviour to that reported here. Various explanations were put forward, including the heating of an accidental puddle of electrons within the barrier [5], impurities exchanging electrons [6], and interplay with gate leakage current [8]. In many of these cases, however, the bistability occured under conditions when the substrate eld vanished (after illumination), indicating that the mechanism proposed here may explain these experiments as well.

The device geom etry, heterostructure composition and measurement conguration are indicated in g.1(a). The back gate is a 50 nm layer of n+ GaAs which is contacted separately from the 2DEG using in situ ion-beam patterning (see ref. [9]). Above this is a 500 nm AlGaAs barrier, followed by 500 nm of GaAs at the top of which is the normal heterojunction. At $V_g = 0$, a 2DEG of density 2:5 10^{11} cm 2 and mobility 3:0 10^5 cm 2 V 1 s 1 resides at this heterojunction. The barriers in the 2DEG are produced by electron-beam lithography and wet etching on the arms of a Hall-bar mesa. The etch width (200 nm) and depth (50 nm) create a potential barrier at the heterojunction that is known to be hundreds ofmillivolts high [10]; enough to make the barriers completely insulating at both room and low temperature [11].

Fig. 1 (b) shows the I-V characteristics of a barrier at tem perature $T=4.2~\rm K$ for dierent gate voltages V_g . A bias V of up to $100~\rm m~V$ is applied to one contact, and the current I is measured with a virtual-earth current preampli er attached to the other contact. As V_g is increased from zero, I is zero until $V_g=1.53~\rm V$. Then, up to $V_g=1.60~\rm V$, I remains zero at low V but grows rapidly above a threshold bias. Near this threshold there is bistability between a low-and a high-current state, causing hysteresis between up and down sweep directions (indicated by arrows at $V_g=1.54~\rm V$) [12]. The threshold bias (the value of V at which I in the high-current state extrapolates to zero) decreases towards a limiting value $V_{lim}=40~\rm m~V$ as V_g is increased. At $V_g=1.60~\rm V$ the bistability disappears and simultaneously the conductance at $V=0~\rm becom~es$ nite. Measurements on a number of barriers revealed very similar characteristics.

To understand these results, we set consider the elect of y on the unetched 2DEG. The solid line in g. 2(a) is the density, η , of the 2DEG deduced from the low-eld Hall coe cient of an unetched region, while the led circles here are the values of η obtained from Shubnikov-de Haas oscillations. We see that η_1 increases linearly with V_g up to about 1.4 V, above which it levels oat 3.5 lour case 10 cm for this levelling o [9] is the population of a second 2DEG, as is illustrated by the band diagrams in g. 3. At $V_g=0$ the lower heterojunction, at the bottom of the 500 nm GaAs layer, is far above E_F and the electrons are tightly conned by the electric eld in the GaAs to the upper heterojunction. The linear increase in η_1 for $V_g<1.4$ V is determined by the capacitance between the upper heterojunction and the back gate, whose separation is 1020 nm. At $V_g=1.4$ V the lower

heterojunction reaches the FermilevelE $_{\rm F}$ and a second 2DEG forms there. For $V_{\rm g} > 1.4~V$, the band in the GaAs remains almost at, and $n_{\rm l}$ remains constant. The density $n_{\rm 2}$ in the lower 2DEG then increases according to the dashed line.

Now we exam ine the properties of the barrier over the same range of V_g . Fig. 2 (b) shows the dierential conductance, $\frac{dI}{dV}$, at V=0 and $100\,\text{m}\,V$. Both become nite only for V_g 1.5 V. The inset shows the variation with magnetic eld B of $\frac{dV}{dI}$ $\frac{dI}{dV}$) 1 , at $V=100\,\text{m}\,V$ and $V_g=1:72\,V$. It is roughly linear for B $0:5\,T$, suggestive of a Hall resistance. The same is true at other values of V_g . If at each V_g we interpret the slope as a Hall coexcient, $R_H=\frac{d\left(\frac{dI}{dV}\right)}{dB}$, and convert it to a number density (eR $_H$) 1 , we obtain the open circles plotted in g. 2 (a). The results closely follow the predicted behaviour of p_e .

A m ed with our understanding of the behaviour of the upper and lower 2D EGs, we can readily interpret these results. The explanation is sketched in g.4(a). The repulsive potential created by the etched surface is smallest at the lower heterojunction, as indicated by the contours. It is therefore clear why the barrier only conducts once the gate voltage is such that the lower heterojunction is populated. The current owspast the barrier along the lower 2D EG. The onset of nonlinear conduction in the I-V curves can also be understood. To get from the upper to the lower 2D EG, the electrons must be eldemitted from the upper 2D EG. By analogy with eldemission in metals, this happens above a characteristic electric eld and hence a well defined a source-drain bias.

To understand this in m ore detail, we need to consider the transfer rate from the upper to the low er 2D EG and the conductance G $_2$ of the low er 2D EG . We rst discuss the variation of G $_2$ w ith V $_g$. For V $_g<1.4$ V , n_2 = 0 and hence G $_2$ = 0. For a range of V $_g$ above this, n_2 is low enough that localization by disorder causes G $_2$ to be activated, ie, G $_2$ = G $_0$ exp [E_a =k $_B$ T]. As n_2 increases, the high-T conductance G $_0$ should increase while the activation energy E $_a$ decreases until at some point G $_2$ becomes measurable at 4.2 K . It is reasonable that this happens at V $_g$ = 1.6 V , when n_2 3 10^0 cm 2 . In support of this we indicated in additional measurements that the linear-response barrier conductance is activated, with E $_a$ = 1.3 m V and G $_0$ = 38 m S at V $_g$ = 1.66 V , and that E $_a$ decreases while G $_0$ increases with increasing V $_g$. This scenario is conimined by the observation that the magnetoresistance of the I-V curves accurately rejected the expected Halle extraorder at high B. In other words, the on-state resistance is dominated by the resistance of the lower 2D EG .

Having understood the role of the lower 2DEG, we can now ask how eld emission from the upper 2DEG is related to the nonlinearity and bistability seen in g. 1(b). As V is increased, the electric eld between the upper and lower heterojunctions grows. When the eld perpendicular to the 2D EG reaches som e value we expect the rate of electron escape from the upper 2D EG on the negative (left) side of the barrier to rise rapidly, by analogy with eld em ission from a metal cathode. This is indicated in g. 4 (b). Variational calculations of the 2D subband wavefunctions imply that a 2D EG eventually becomes unstable (to eldemission) as the substrate potential is lowered [13]. We can check that within our self-consistent simulation the onset of eld emission is sudden. We take the situation in g. 3 with the lower 2DEG occupied, and incorporate a potential drop V across the GaAs well [14]. At V = 0, all the lower-energy wavefunctions are strongly localized to one or the other side of the well. However, as V is increased, at some point the second subband on the left side of the well develops a tail on the right side. The integrated probability in the tail can be approxim ated by V_{fe})=], where V_{fe} and d are constants. Since once this tail forms electrons in the second subband can spill out of the upper 2D EG across the well, we identify Vfe with the eld em ission threshold within the model. Correspondingly, is the characteristic bias range over which eld emission starts. The value of V_{fe} obtained depends on the acceptor concentration

in the GaAs layer. A concentration of 2:0 10^{11} cm 3 gives $V_{\text{fe}} = 31 \text{ m V}$ and = 1:6 m V. For all acceptor concentrations we nd V_{fe} , implying that the onset of eldem ission is indeed sudden.

If eld em ission only increased the transfer rate across the well, then the current would quickly be limited by G_2 and the I-V curves would simply show a turn-on above a threshold voltage. However, each eld-emitted electron delivers an excess energy of up to e V to the lower 2D EG, where V is the potential dierence between the upper and lower 2D EGs in the eld emission region. This may be expected to cause the electron temperature T in the lower 2D EG to increase, thereby decreasing G_2 and increasing the current. Within such a scenario a bistability arises naturally [15]. We illustrate this by representing the barrier by the simplied equivalent circuit in the inset to g. 4 (c), consisting of a diode of turn-on voltage $V_{\rm e}$ in series with the activated conductance $G_0 \exp \left[E_a = k_B T \right]$. To increases monotonically with VI, the power dissipated. Our justic cation for neglecting the resistance for current returning from the lower to the upper 2D EG is that the hot electrons can easily traverse the well once they have passed the barrier. Such a circuit exhibits an S-shaped bistable region in its I-V characteristic, due to them all runaway in the lower 2D EG [15]. Fig. 4 (c) shows a characteristic generated using a simple proportional relationship, T = IV and reasonable values of the parameters (see gure caption) chosen for similarity to the data at $V_0 = 1.55$ V in g. 1 (b).

A coording to this model, the limiting threshold bias, V_{lim} , defined in the discussion of g. 1(b), is a measure of the eld-em ission threshold, $Y_{\rm e}$. One may therefore estimate the electric eld for eldem ission to be $F_{\rm e}$ V_{lim} =d, where d is the GaAs well width. For this device we get (40 m V)/(0.5 mm) = 8 10 4 Vm 1 . This is much lower than for 3D metals, where eldem ission typically occurs at around 10 6 Vm 1 [16]. Of particular interest is the situation where there is no doping in the substrate, and the intrinsic work function [3] may be investigated. Our simulations indicate that $E_{\rm fe}$ is around 5 10 6 Vm 1 in this limit. Note that the threshold bias should depend on the geometry of the emitter, with a sharper point resulting in a lower threshold. Future work will address these issues.

Finally, we note that escape from a 2DEG can easily occur whenever the potential is nearly at in the GaAs substrate. In the present devices, this situation is brought about by making V_g su ciently positive. It is known, however, that illumination with an LED at low temperatures also attens the bands in the GaAs by neutralizing acceptors deep in the substrate [2]. Indeed, we have previously seen very similar behaviour in etched barriers on standard heterostructures with no back gate, but only after illumination with red light at $4.2~\mathrm{K}$ [4], and we have subsequently found that a voltage applied to the chip carrier has much the same election the characteristics as has V_g in the present devices. These standard heterostructures too have an upside-down heterojunction around 1 miles below the normalone, at the top of the superlattice builties. In Refs. [5, 6, 7] infrared illumination was also applied before the nonlinear and bistable behaviour was observed. We therefore believe that the mechanism described here can explain the puzzling behaviour seen in their standard heterostructure devices as well.

In conclusion, we have demonstrated a nonlinear device that relies on the eld emission of electrons from a 2DEG trapped at a heterointerface to a second 2DEG beneath it. The device exhibits bistable I-V's associated with a thermal runaway in the second 2DEG due to heating by the eld-emitted electrons. This study opens the way for investigations of the work function of 2D metals [3]. Our experiments show that electrons can escape from 2DEGs more easily than is often appreciated, and this may help to explain the frequent occurrence of nonlinear/bistable behaviour in a variety of heterostructure devices.

discussions. This work was supported by the O ce of Naval Research (LBNL authors), the UK EPSRC (IMC and EHL), and Toshiba Cambridge Research Center (DAR).

- Fig. 1 (a) Schem atic view of a device, indicating the layer structure and measurement con guration. (b) I-V characteristics at a series of V_g . In each case V was swept up and down once.
- Fig. 2 (a) A real electron densities $vs\,V_g$. The density of the upper 2D EG, n_1 , is obtained both from Hall (solid trace) and Shubnikov-de Haas (led circles) measurements. The dashed line is the predicted density n_2 of the lower 2D EG. (b) Di erential conductance $vs\,V_g$ at V=1 m V and 100 m V. The inset shows an example of the linear variation of $\frac{dV}{dI}$ with magnetic eld at V=100 m V, from which the density values plotted as open circles in (a) are derived.
- Fig. 3. Self-consistent band prolles in the unetched heterostructure at three values of V_g , separated by 0.5 V of sets for clarity. The electron density, shaded in black, is superimposed. Uniform negative acceptor densities of 2.0 10^{14} cm 3 in the GaAs and 6.5 10^{15} cm 3 in the AlG aAs were included, the latter being chosen to bring the lower heterofunction to E $_F$ at $V_g=1.4$ V.
- Fig. 4. Depiction of current ow past an etched barrier. Contours of potential energy are sketched in, the highest being the one closest to the etched surface. (a) At low bias, only equilibrium transfer occurs between upper and lower 2DEGs. (b) At higher bias (negative on the left), electrons can be eld emitted from the upper 2DEG near the barrier. (c) Characteristic of the simplied equivalent circuit (inset) taking $V_{\rm fe} = 38~{\rm m\,V}$, $G_0 = 2~{\rm m\,S}$, $E_a = 2.5~{\rm m\,eV}$, and $T_c = TV_c$ with $T_c = 2~{\rm K/pW}$.

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